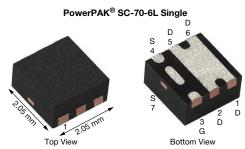
Vishay Siliconix

# N-Channel 8 V (D-S) MOSFET



Marking code: AO

PRODUCT SUMMARY	
V <sub>DS</sub> (V)	8
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.0094
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 2.5 \text{ V}$	0.0105
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 1.8 \text{ V}$	0.0125
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 1.5 \text{ V}$	0.0180
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 1.2 \text{ V}$	0.0360
Q <sub>g</sub> typ. (nC)	15
I <sub>D</sub> (A) <sup>a</sup>	12
Configuration	Single

#### **FEATURES**

- TrenchFET® power MOSFET
- Thermally enhanced PowerPAK® SC-70 package
  - Small footprint area

100 % R<sub>a</sub> tested

 Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

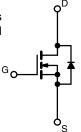


RoHS COMPLIANT

COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- Load switch for portable applications such as smart phones, tablet PCs, and mobile computing
  - Low voltage gate drive
  - Low voltage drop
  - Power switch for ICs



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA436DJ-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)								
PARAMETER		SYMBOL	LIMIT	UNIT				
Drain-source voltage		$V_{DS}$	8	V				
Gate-source voltage		$V_{GS}$	± 5	ľ				
	T <sub>C</sub> = 25 °C		12 <sup>a</sup>					
Continuous drain surrent (T. 150 °C)	T <sub>C</sub> = 70 °C	I <sub>D</sub>	12 <sup>a</sup>	Ī				
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C		12 <sup>a, b, c</sup>	Ī				
	T <sub>A</sub> = 70 °C		12 <sup>a, b, c</sup>	Α				
Pulsed drain current (t = 300 μs)		I <sub>DM</sub>	50					
Continuous source dusin diede current	T <sub>C</sub> = 25 °C		12 <sup>a</sup>	1				
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.9 b, c	Ī				
	T <sub>C</sub> = 25 °C		19					
Mayimum nauvar disainatian	T <sub>C</sub> = 70 °C		12	w				
Maximum power dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.5 <sup>b, c</sup>	T VV				
	T <sub>A</sub> = 70 °C	1	2.2 <sup>b, c</sup>	Ī				
Operating junction and storage temperature	range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C				
Soldering recommendations (peak tempera	ture) <sup>d, e</sup>		260					

THERMAL RESISTANCE RATINGS									
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT				
Maximum junction-to-ambient b, f	t ≤ 5 s	$R_{thJA}$	28	36	°C/W				
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	5.3	6.5	C/VV				

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 80 °C/W



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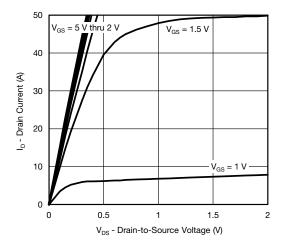
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	'				L	L
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	8	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	. OFO A	-	11	-	>//00
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-2.5	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$	0.35	-	0.8	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$	-	-	± 100	nA
Zana and a silvan darka a sanat		V <sub>DS</sub> = 8 V, V <sub>GS</sub> = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 8 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	20	-	-	Α
	, ,	$V_{GS} = 4.5 \text{ V}, I_D = 15.7 \text{ A}$	-	0.0078	0.0094	
		$V_{GS} = 2.5 \text{ V}, I_D = 14.9 \text{ A}$	-	0.0087	0.0105	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 1.8 \text{ V}, I_D = 13.6 \text{ A}$	-	0.0104	0.0125	Ω
	, ,	$V_{GS} = 1.5 \text{ V}, I_D = 2.5 \text{ A}$	-	0.0120	0.0180	
		$V_{GS} = 1.2 \text{ V}, I_D = 1.5 \text{ A}$	-	0.0180	0.0360	
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = 4 \text{ V}, I_D = 15.7 \text{ A}$	-	70	-	S
Dynamic <sup>b</sup>				1		ı
Input capacitance	C <sub>iss</sub>		-	1508	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 4 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	535	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	321	-	
	Q <sub>g</sub>	$V_{DS} = 4 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 15.7 \text{ A}$	-	16.8	25.2	nC
Total gate charge			-	15	23	
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 4 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 15.7 \text{ A}$	-	1.7	-	
Gate-drain charge	$Q_{gd}$		-	0.9	-	
Gate resistance R <sub>q</sub>		f = 1 MHz	0.5	2.5	5	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	11	20	
Rise time	t <sub>r</sub>	$V_{DD} = 4 \text{ V}, R_L = 0.4 \Omega$	-	10	20	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10$ Å, $V_{GEN} = 4.5$ V, $R_g = 1$ $\Omega$	-	30	45	
Fall time	t <sub>f</sub>		-	8	16	
Turn-on delay time	t <sub>d(on)</sub>		-	10	20	ns
Rise time	t <sub>r</sub>	$V_{DD} = 4 \text{ V. R}_1 = 0.4 \Omega$	-	10	20	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 5 \text{ V}, R_g = 1 \Omega$	-	30	45	
Fall time	t <sub>f</sub>		-	8	16	
<b>Drain-Source Body Diode Characteristic</b>						
Continuous source-drain diode current	ntinuous source-drain diode current I <sub>S</sub>		-	-	12	А
Pulse diode forward current	ulse diode forward current I <sub>SM</sub>		-	-	50	
Body diode voltage	$V_{SD}$	$I_S = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.73	1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	10	20	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	1	4	nC
Reverse recovery fall time	t <sub>a</sub>	T <sub>J</sub> = 25 °C	-	4	-	
Reverse recovery rise time	t <sub>b</sub>		_	6	-	ns

#### Notes

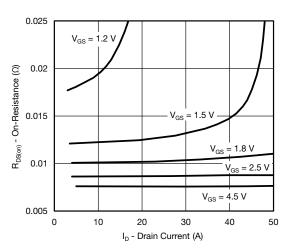
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

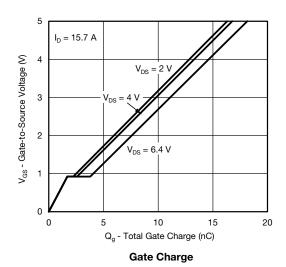


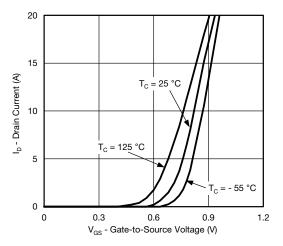


#### **Output Characteristics**

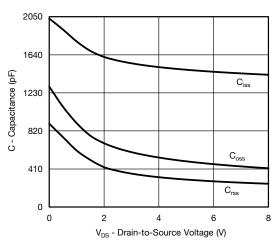


On-Resistance vs. Drain Current and Gate Voltage

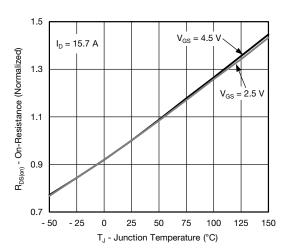




**Transfer Characteristics** 

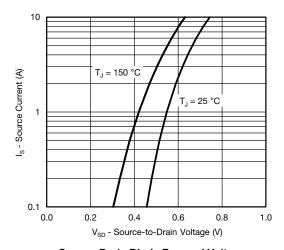


Capacitance

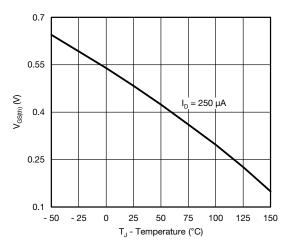


On-Resistance vs. Junction Temperature

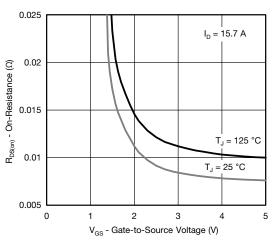




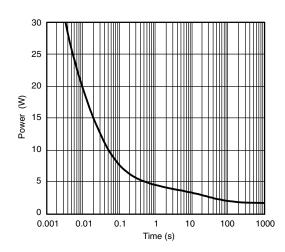
#### Source-Drain Diode Forward Voltage



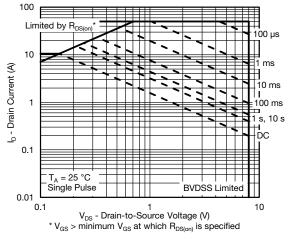
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

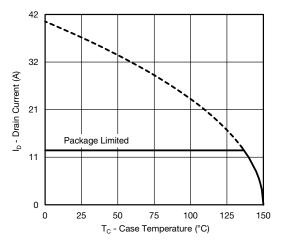


Single Pulse Power (Junction-to-Ambient)

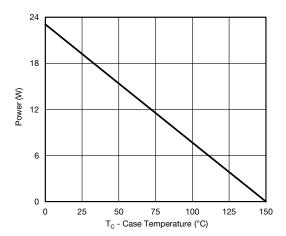


Safe Operating Area, Junction-to-Ambient

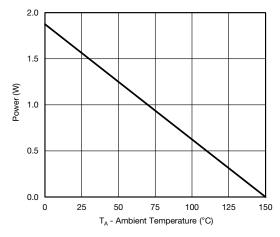




Current Derating a





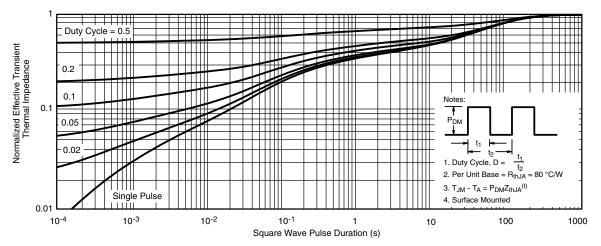


Power Derating, Junction-to-Ambient

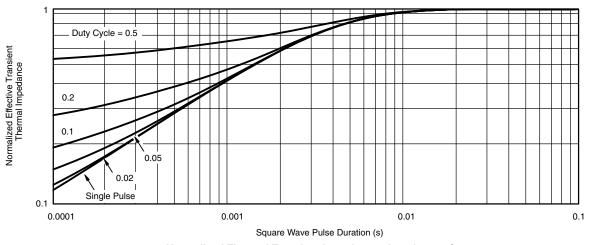
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

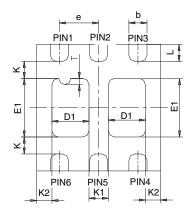
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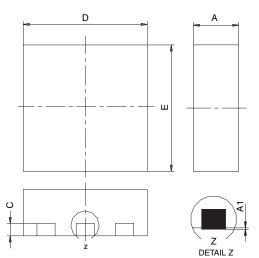
## PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
  Package outline exclusive of mold flash and metal burr
  Package outline inclusive of plating

	SINGLE PAD						DUAL PAD						
DIM	M	ILLIMETER	RS	INCHES			MILLIMETERS			INCHES			
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032	
<b>A</b> 1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002	
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015	
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010	
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028	
D2	0.135	0.235	0.335	0.005	0.009	0.013							
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041	
E2	0.345	0.395	0.445	0.014	0.016	0.018							
E3	0.425	0.475	0.525	0.017	0.019	0.021							
е		0.65 BSC			0.026 BSC	;	0.65 BSC			0.026 BSC			
K		0.275 TYP			0.011 TYP	1	0.275 TYP			0.011 TYP			
K1		0.400 TYP			0.016 TYP			0.320 TYP			0.013 TYP		
K2		0.240 TYP			0.009 TYP			0.252 TYP			0.010 TYP		
К3		0.225 TYP		0.009 TYP									
K4		0.355 TYP		0.014 TYP									
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015	
Т							0.05	0.10	0.15	0.002	0.004	0.006	
ECN: C-07431 - Rev. C. 06-Aug-07													

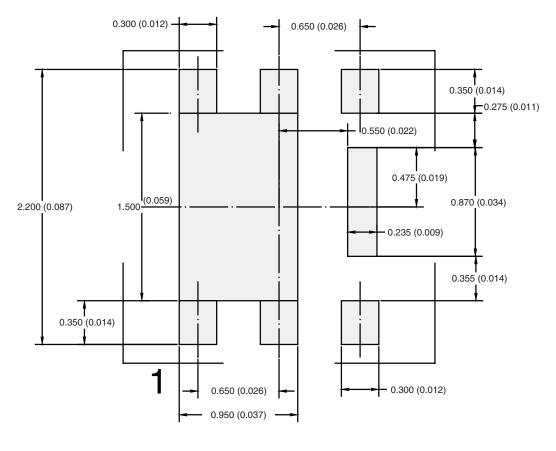
DWG: 5934

Document Number: 73001 06-Aug-07

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## RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

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ATTLICATION NOTE

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Vishay

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